

# R2A20131SP

## Continuous Conduction Mode PFC Control IC

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### **Description**

The R2A20131 is power factor correction control IC of continuous conduction mode.

The R2A20131 is built in Load Tracing Boost, Brownout, Over Voltage Protection, Over Current Protection, FeedBack loop Open detection and Power Good Function.

Load tracing boost function bring improvement of efficiency at light load with few external parts.

The feedback loop open detection, and over current protection are built in the R2A20131, and can constitute a power supply system of high reliability with few external parts.

Power Good Function monitors PFC output voltage and can adjust no-good level.

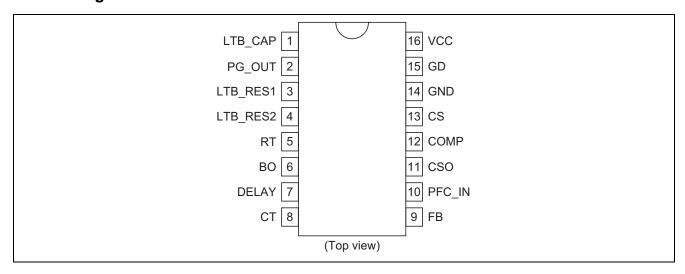
#### **Features**

- Absolute Maximum Ratings
  - Supply voltage Vcc: 24 V
  - Operating junction temperature Tjopr: –40 to +150°C
- Electrical Characteristics
  - Error amplifier reference voltage Vfb:  $2.51 \text{ V} \pm 1.5\%$
  - UVLO operation start voltage Vuvlh: 10.5 V  $\pm$  0.7 V
  - UVLO operation shutdown voltage Vuvll: 9.3 V  $\pm$  0.5 V
  - UVLO hysteresis voltage Hysuvl:  $1.2 \text{ V} \pm 0.5 \text{ V}$
- Functions
  - Boost converter control with continuous conduction mode
  - Load Tracing Boost (LTB) function: Vout is decreased at light load and AC 100 V system.
  - Brownout function
  - Over Voltage Protection
  - Feedback loop Open detection
  - Over Current Protection
  - Power good information (Open drain output)
  - Package: Pb-free SOP-16
    - This Device uses Halogen-Free Molding Compound

### **Ordering Information**

Part No.	Package Name	Package Code	Package Abbreviation	Taping Abbreviation (Quantity)
R2A20131SP#W0	_	PRSP0016DH-B	SP	W (2,000 pcs/reel)

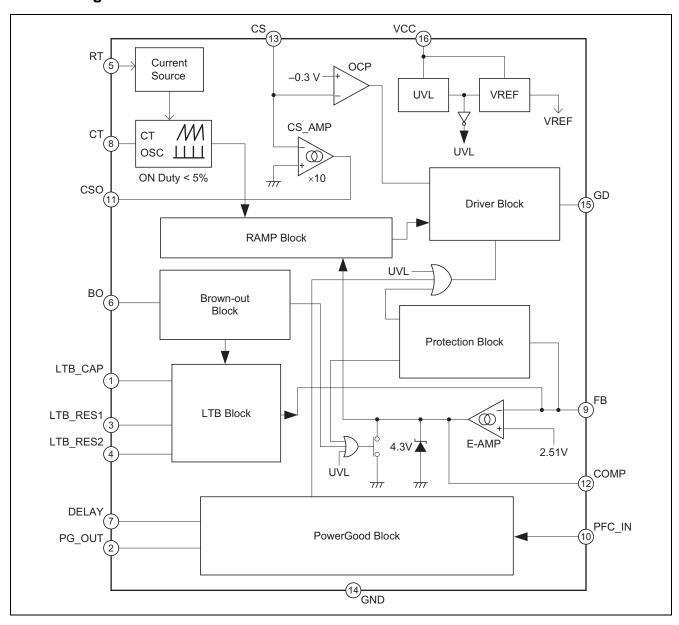
## **Pin Arrangement**



## **Pin Functions**

Pin No.	Pin Name	Input/Output	Function
1	LTB_CAP	Input	Load tracing boost stability capacitor connection terminal
2	PG_OUT	Output	Power Good Output terminal for house keeping
3	LTB_RES1	Output	Load tracing boost adjust resistor connection terminal1
4	LTB_RES2	Output	Load tracing boost adjust resistor connection terminal2
5	RT	Input/Output	Oscillator frequency setting and internal bias current setting terminal
6	ВО	Input	Brownout input terminal
7	DELAY	Input/Output	PG_OUT ON Delay adjustable terminal
8	СТ	Output	Oscillator frequency setting terminal
9	FB	Input	Error amplifier input terminal
10	PFC_IN	Input	Power Good detection terminal
11	CSO	Output	Current amplifier output terminal
12	COMP	Output	Error amplifier output terminal
13	CS	Input	Current detection terminal
14	GND	_	Ground
15	GD	Output	Power MOSFET drive terminal
16	VCC	Input	Supply voltage terminal

## **Block Diagram**



## **Absolute Maximum Ratings**

 $(Ta = 25^{\circ}C)$ 

Item	Symbol	Ratings	Unit	Note
Supply voltage	VCC	-0.3 to +24	V	
GD sink current	Isnk-gd	1.2	А	3
GD source current	Isrc-gd	-0.8	А	3
GD DC sink current	ldc-snk-gd	0.12	А	
GD DC source current	ldc-src-gd	-80	mA	
CS terminal voltage	Vt-cs	-5 to +0.3	V	
BO terminal current	Ibom	300	μΑ	
RT terminal current	Irt	-200	μΑ	
COMP terminal current	Icomp	±1	mA	
LTB_RES terminal current	Iltb_res	-100	μΑ	
PG_OUT terminal current	lpg_out	25	mA	
Terminal voltage	Vt-group	-0.3 to +5.5	V	4
Terminal voltage2	Vt-group2	-0.3 to VCC	V	5
Terminal voltage3	Vt-group3	-0.3 to +24	V	6
Power dissipation	Pt	1	W	7
Operating junction temperature	Tj-opr	-40 to +150	°C	
Storage temperature	Tstg	-55 to +150	°C	

Notes: 1. Rated voltages are with reference to the GND terminal.

- 2. For rated currents, inflow to the IC is indicated by (+), and outflow by (-).
- 3. Shows the transient current when driving a capacitive load.
- 4. This is the rated voltage for the following pins: FB, COMP, BO, RT, CT, LTB\_CAP, LTB\_RES1, LTB\_RES2, CSO, PFC\_IN, DELAY
- 5. This is the rated voltage for the following pin:
- 6. This is the rated voltage for the following pin: PG\_OUT
- 7. In case of R2A20131SP (SOP):  $\theta$ ja = 120°C/W This value is a thing mounting on  $40 \times 40 \times 1.6$  [mm], a glass epoxy board of wiring density 10%.

## **Electrical Characteristics**

 $(Ta=25^{\circ}C,\ VCC=12\ V,\ RT=33\ k\Omega,\ PFC\_IN=GND,\ CT=470\ pF,\ CS=GND,\ FB=COMP,\ BO=4\ V,\ LTB\_RES1=33\ k\Omega,\ LTB\_RES2=33\ k\Omega)$ 

Item		Symbol	Min	Тур	Max	Unit	Test Conditions
Supply	UVLO turn-on threshold	Vuvlh	9.8	10.5	11.2	٧	
	UVLO turn-off threshold	VuvII	8.8	9.3	9.8	٧	
	UVLO hysteresis	Hysuvl	0.7	1.2	1.7	٧	
	Standby current	Istby	_	100	180	μΑ	VCC = 8.9 V
	Operating current	Icc	_	2.5	4	mA	
Brownout	BO threshold voltage	Vbo	1.35	1.40	1.45	V	
	BO pin hysteresis current	lbo	(3.3) ×0.92	(3.3)	(3.3) ×1.08	μΑ	BO = 1 V, RT = 33 kΩ
	BO pin current	lbo2	0.05	0.15	0.4	μΑ	BO = 2 V
Error	Feedback voltage	Vfb	2.472	2.51	2.548	V	FB-COMP short
amplifier	Input bias current	lfb	-0.4	-0.15	-0.05	μΑ	Measured pin: FB FB = 3 V
	Open loop gain	Av	_	50	_	dB	*1
	Upper clamp voltage	Vclamp_comp	4.0	4.3		٧	FB = 2.0 V COMP: Open
	Low voltage	VI-comp	_	0.1	0.3	V	FB = 3.0 V COMP: Open
	Transconductance	gm	100	180	270	μS	FB = 2.5 V COMP: 2.5 V
Oscillator	Initial accuracy	fGD	58.5	65	71.5	kHz	Measured pin: GD
	fout temperature stability	dfout/dTa	_	±0.1	_	%/°C	Ta = −40 to 125°C * <sup>1</sup>
	fout voltage stability	fout-line	-1.5	0.5	1.5	%	VCC = 12 V to 18 V
	RT voltage	Vrt	1.595	1.65	1.705	V	
Over	OCP threshold voltage	Vocp	-0.315	-0.3	-0.285	V	
current protection	CS bias current	Ics	-130	-100	-60	μА	Measured pin: CS
Current AMP	CSO output voltage	V-cso	0.8	1	1.2	V	CS = -0.1 V
Load tracing boost	Source current	Iltb	(-21.2) ×1.05	(-21.2)	(–21.2) ×0.95	μА	BO = 2V, LTB_CAP = 0 V FB = 2.5 V, PFC_IN = 3 V Measure pin: FB
	High threshold voltage	Vltb-hi	3.2	3.6	4.0	V	Measured pin: BO
	Low threshold voltage	VItb-lo	2.9	3.2	3.5	V	
POWER GOOD	PFC_IN threshold voltage 1	Vpfc_in1	2.42	2.5	2.58	V	
function	PFC_IN hysteresis current	lpfc_in1	(-10) ×1.08	(–10)	(-10) ×0.92	μΑ	PFC_IN = 3 V, RT = 33 k $\Omega$
	PFC_IN current	lpfc_in2	-0.4	-0.15	-0.05	μΑ	PFC_IN = 2 V
	PG OUT leak current	lpgh	_	_	5	μΑ	PFC_IN = GND VPG_OUT = 5 V
	PG OUT low voltage	Vpgl	_	_	0.4	V	PFC_IN = 3 V PG OUT sink current = 20 mA

Note: \*1 Design spec

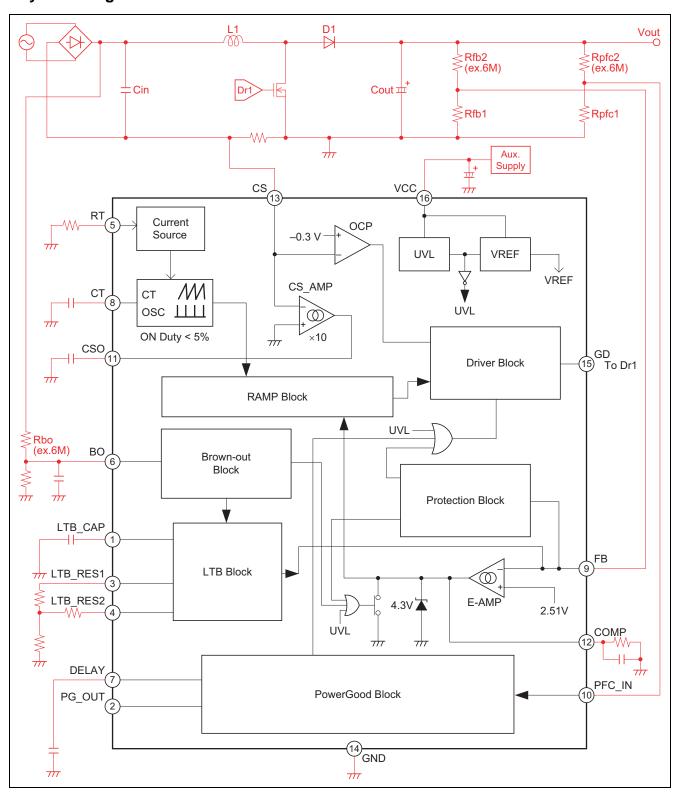
## **Electrical Characteristics** (cont.)

 $(Ta=25^{\circ}C,\ VCC=12\ V,\ RT=33\ k\Omega,\ PFC\_IN=GND,\ CT=470\ pF,\ CS=GND,\ FB=COMP,\ BO=4\ V,\ LTB\_RES1=33\ k\Omega,\ LTB\_RES2=33\ k\Omega)$ 

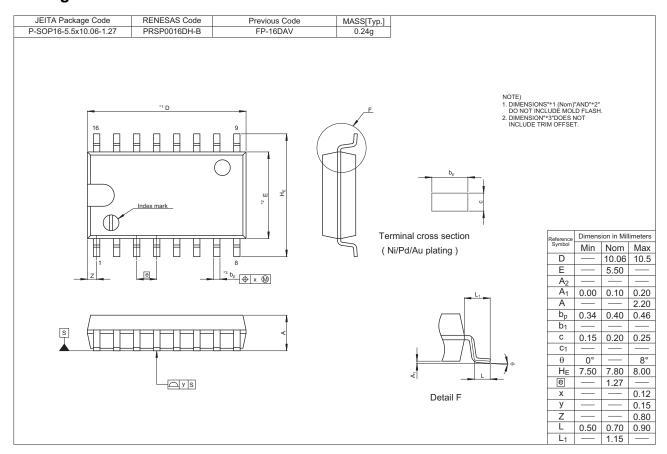
Item		Symbol	Min	Тур	Max	Unit	Test Conditions
Gate drive	Gate drive rise time	tr-gd	_	30	100	ns	GD: 1.2 V to 10.8 V CL = 1000 pF
	Gate drive fall time	tf-gd	_	30	100	ns	GD: 10.8 V to 1.2 V CL = 1000 pF
	Gate drive low voltage	Vol1-gd	_	0.02	0.1	V	Isink = 2 mA
		Vol2-gd		0.01	0.2	V	Isink = 1 mA, VCC = 5 V
	Gate drive high voltage	Voh-gd	11.5	11.9	_	<b>V</b>	Isource = -2 mA
	Maximum duty	Dmax	90	95	98	%	COMP: Open, FB = 2 V CSO = GND
	Minimum duty	Dmin	_	_	0	%	FB = 2.5 V COMP: GND
Over voltage	OVP threshold voltage	Vovp	VFB× 1.065	VFB× 1.080	VFB× 1.095	V	COMP = 2.5 V
protection	OVP hysteresis	Hys-ovp	50	100	150	mV	COMP = 2.5 V
	FB low detect threshold voltage	Vfblow	0.25	0.3	0.35	V	COMP = 2.5 V
PG on delay	DELAY threshold voltage	Vdelay	2.85	3	3.15	V	PFC-IN = 3 V
	DELAY charge current	Ichrg-delay	-7	<b>-</b> 5	-3	μА	DELAY = 2.5 V, PFC-IN = 3 V

Note: \*1 Design spec

## **System Diagram**



## **Package Dimensions**



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